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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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TECHNOLOGY CENTER 2800

In re Patent Application of

Mark Pavier

Date: July 19, 2001

Serial No.: 09/718,932

Group Art Unit: 2812

Filed: November 22, 2000

Examiner: A. Roman

For: POWER SEMICONDUCTOR DIE ATTACH PROCESS USING  
CONDUCTIVE ADHESIVE FILM

Asst. Commissioner for Patents  
Washington, D.C. 20231

### AMENDMENT/SUBMISSION

This is a response to the Office Action mailed June 15, 2001 in the above-identified application. Reconsideration of the application is respectfully requested.

### FEE CALCULATION

Any additional fee required has been calculated as follows:

	NO. CLAIMS		HIGHEST NO.				ADDIT.
	AFTER		PREVIOUSLY				
	AMENDMENT		PAID FOR	EXTRA PRESENT	RATE	FEE	
TOTAL	12	MINUS	20	* =	X	(\$9 SE or \$18)	\$
INDEP.	2	MINUS	3	** =	X	(\$40 SE or \$80)	\$
FIRST PRESENTATION OF MULTIPLE DEPENDENT CLAIM					X	(\$135 SE or \$270)	\$
						TOTAL \$	

\* not less than 20 \*\* not less than 3

If any additional payment is required, a check which includes the calculated fee of \$\_\_\_\_\_  
(OFGS Check No. \_\_\_\_\_) is attached.